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(54) **COMPOSITIONS AND METHODS FOR ELECTRODEPOSITING TIN-BISMUTH ALLOYS ON METALLIC SUBSTRATES**

ZUSAMMENSETZUNGEN UND VERFAHREN ZUR ELEKTROABSCHEIDUNG VON  
ZINNWISMUTLEGIERUNGEN AUF METALLISCHEN SUBSTRATEN

COMPOSITIONS ET PROCÉDÉS POUR LE DÉPÔT GALVANIQUE D'ALLIAGES D'ÉTAIN-BISMUTH  
SUR DES SUBSTRATS MÉTALLIQUES

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